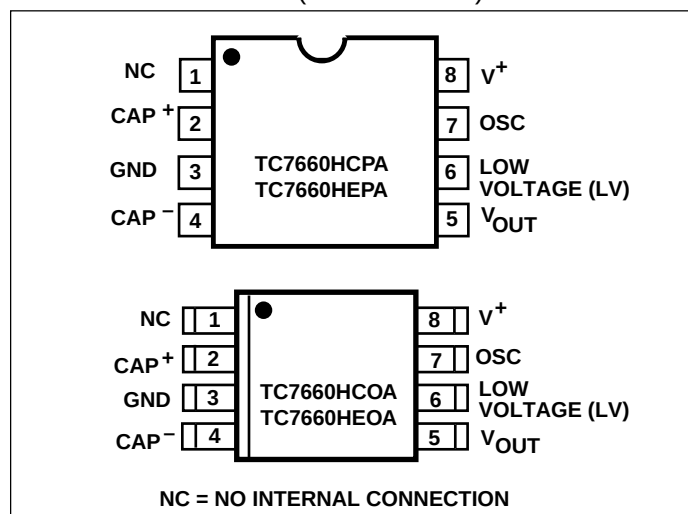


HIGH FREQUENCY 7660 DC-TO-DC VOLTAGE CONVERTER

FEATURES

- Pin Compatible with 7660, High Frequency Performance DC-to-DC Converter
- Low Cost, Two Low Value External Capacitors Required (1.0 μ F)
- Converts +5V Logic Supply to $\pm$ 5V System
- Wide Input Voltage Range 1.5V to 10V
- Voltage Conversion 99.7%
- Power Efficiency 85%
- Available in 8-Pin SOIC and 8-Pin PDIP Packages

PIN CONFIGURATION (DIP and SOIC)



GENERAL DESCRIPTION

The TC7660H is a pin-compatible, high frequency upgrade to the Industry standard TC7660 charge pump voltage converter. It converts a +1.5V to +10V input to a corresponding - 1.5V to - 10V output using only two low-cost capacitors, eliminating inductors and their associated cost, size and EMI.

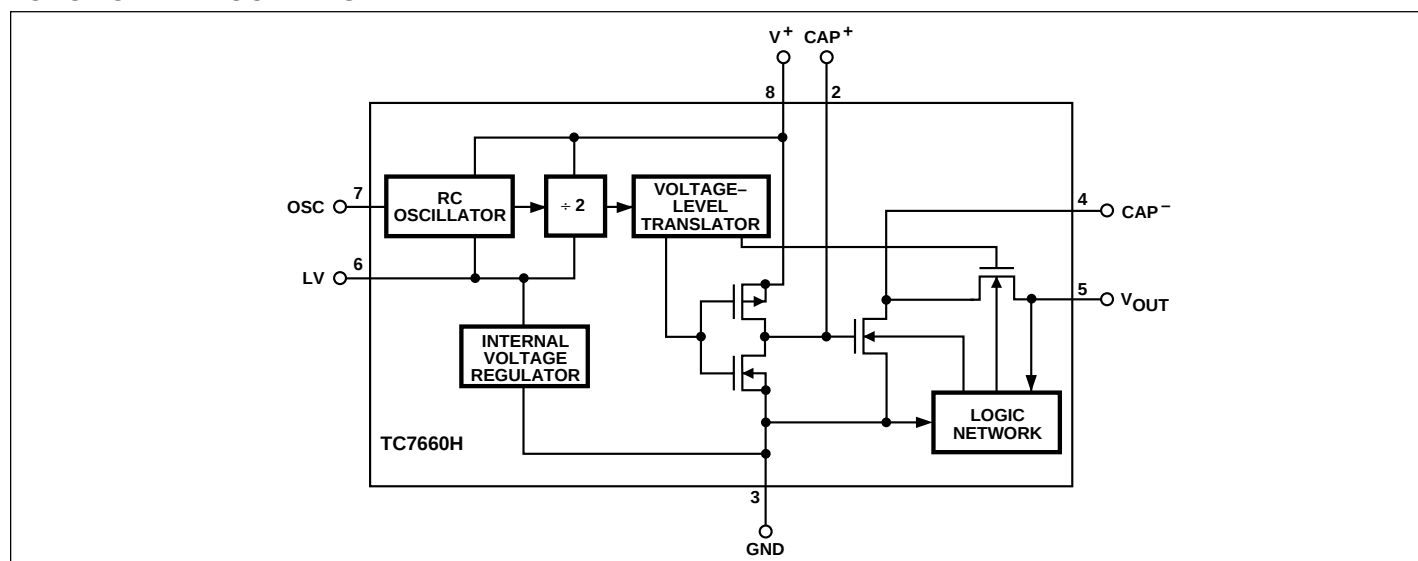
The TC7660H operates at a frequency of 120kHz (versus 10kHz for the TC7660), allowing the use of 1.0 μ F external capacitors. Oscillator frequency can be reduced (for lower supply current applications) by connecting an external capacitor from OSC to ground.

The TC7660H is available in 8-pin DIP and small outline (SOIC) packages in commercial and extended temperature ranges.

ORDERING INFORMATION

Part No.	Package	Temperature Range
TC7660HCOA	8-Pin SOIC	0°C to +70°C
TC7660HCPA	8-Pin Plastic DIP	0°C to +70°C
TC7660HEOA	8-Pin SOIC	- 40°C to +85°C
TC7660HEPA	8-Pin Plastic DIP	- 40°C to +85°C
TC7660EV	Evaluation Kit for Charge Pump Family	

FUNCTIONAL BLOCK DIAGRAM



HIGH FREQUENCY 7660 DC-TO-DC VOLTAGE CONVERTER

TC7660H

ABSOLUTE MAXIMUM RATINGS*

Supply Voltage	+10.5V
LV and OSC Inputs	
Voltage (Note 1)	– 0.3V to ($V^+ + 0.3V$) for $V^+ < 5.5V$ ($V^+ - 5.5V$) to ($V^+ + 0.3V$) for $V^+ > 5.5V$
Current Into LV (Note 1)	20 μ A for $V^+ > 3.5V$
Output Short Duration ($V_{SUPPLY} \leq 5.5V$)	Continuous
Power Dissipation ($T_A \leq 70^\circ C$) (Note 2)	
SOIC	470mW
Plastic DIP	730mW

Operating Temperature Range

C Suffix 0°C to +70°C

E Suffix – 40°C to +85°C

Storage Temperature Range – 65°C to +150°C

Lead Temperature (Soldering, 10 sec) +300°C

*Static-sensitive device. Unused devices must be stored in conductive material. Protect devices from static discharge and static fields. Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operation sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS: Over Operating Temperature Range with $V^+ = 5V$, $C_1 = C_2 = 1\mu F$, $C_{OSC} = 0$, Test Circuit (Figure 1), unless otherwise indicated.

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
I^+	Supply Current	$R_L = \infty$	—	0.46	1.0	mA
V_H^+	Supply Voltage Range, High	$\text{Min} \leq T_A \leq \text{Max}$, $R_L = 5k\Omega$, LV Open	3	—	10	V
V_L^+	Supply Voltage Range, Low	$\text{Min} \leq T_A \leq \text{Max}$, $R_L = 5k\Omega$, LV to GND	1.5	—	3.5	V
R_{OUT}	Output Source Resistance	$I_{OUT} = 20mA$, $T_A = 25^\circ C$	—	55	80	Ω
		$I_{OUT} = 20mA$, $0^\circ C \leq T_A \leq +70^\circ C$ (C Device)	—	—	95	Ω
		$I_{OUT} = 20mA$, $-40^\circ C \leq T_A \leq +85^\circ C$ (E Device)	—	—	110	Ω
		$V^+ = 2V$, $I_{OUT} = 3mA$, LV to GND $0^\circ C \leq T_A \leq +70^\circ C$	—	150	250	Ω
F_{OSC}	Oscillator Frequency		—	120	—	kHz
P_{EFF}	Power Efficiency	$I_{OUT} = 10mA$, $\text{Min} \leq T_A \leq \text{Max}$	81	85	—	%
V_{EFF}	Voltage Efficiency	$R_L = \infty$	99	99.7	—	%

NOTES: 1. Connecting any input terminal to voltages greater than V^+ or less than GND may cause destructive latch-up. It is recommended that no inputs from sources operating from external supplies be applied prior to "power up" of the TC7660H.
2. Derate linearly above 50°C by 5.5mW/°C.

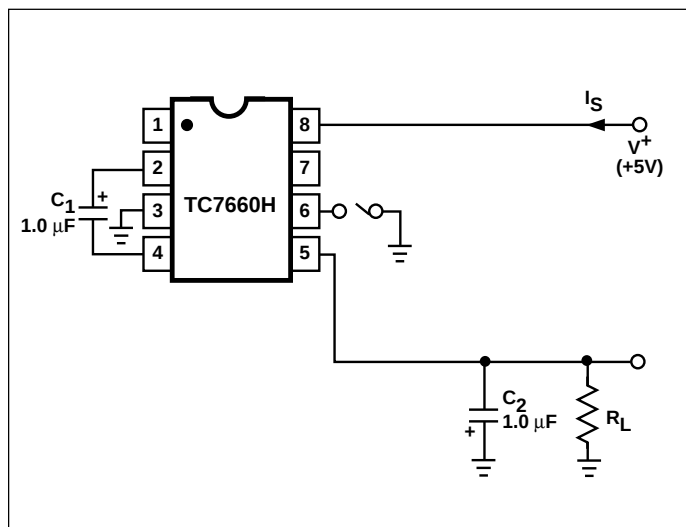


Figure 1. TC7660H Test Circuit

Detailed Description

The TC7660H contains all the necessary circuitry to implement a voltage inverter, with the exception of two external capacitors, which may be inexpensive 1.0μF non-polarized capacitors. Operation is best understood by considering Figure 2, which shows an idealized voltage inverter. Capacitor C_1 is charged to a voltage, V^+ , for the half cycle when switches S_1 and S_3 are closed. (Note: Switches S_2 and S_4 are open during this half cycle.) During the second half cycle of operation, switches S_2 and S_4 are closed, with S_1 and S_3 open, thereby shifting capacitor C_1 negatively by V^+ volts. Charge is then transferred from C_1 to C_2 , such that the voltage on C_2 is exactly V^+ , assuming ideal switches and no load on C_2 .

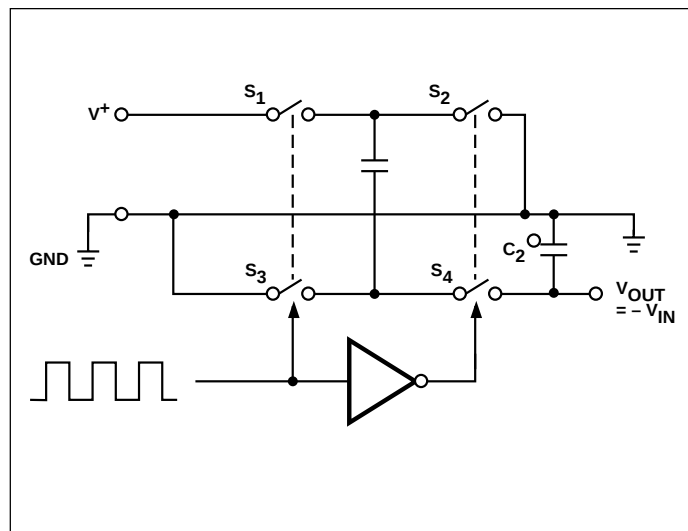


Figure 2. Idealized Charge Pump Inverter

To improve low-voltage operation, the LV pin should be connected to GND. For supply voltages greater than 3.5V, the LV terminal **must be left open to ensure latch-up-proof operation and prevent device damage**.

Theoretical Power Efficiency Considerations

In theory, a capacitive charge pump can approach 100% efficiency if certain conditions are met:

- (1) The drive circuitry consumes minimal power.
- (2) The output switches have extremely low ON resistance and virtually no offset.
- (3) The impedances of the pump and reservoir capacitors are negligible at the pump frequency.

The TC7660H approaches these conditions for negative voltage multiplication if large values of C_1 and C_2 are used. **Energy is lost only in the transfer of charge between capacitors if a change in voltage occurs.** The energy lost is defined by:

$$E = 1/2 C_1 (V_1^2 - V_2^2)$$

V_1 and V_2 are the voltages on C_1 during the pump and transfer cycles. If the impedances of C_1 and C_2 are relatively high at the pump frequency (refer to Figure 1), compared to the value of R_L , there will be a substantial difference in voltages V_1 and V_2 . Therefore, it is not only desirable to make C_2 as large as possible to eliminate output voltage ripple, but also to employ a correspondingly large value for C_1 in order to achieve maximum efficiency of operation.

Do's and Don'ts

- Do not exceed maximum supply voltages.
- Do not connect LV terminal to GND for supply voltages greater than 3.5V.
- Do not short circuit the output to V^+ supply for voltages above 5.5V for extended periods; however, transient conditions including start-up are okay.
- When using polarized capacitors in the inverting mode, the + terminal of C_1 must be connected to pin 2 of the TC7660H and the + terminal of C_2 must be connected to GND Pin 3.

TC7660H

Simple Negative Voltage Converter

Figure 3 shows typical connections to provide a negative supply where a positive supply is available. A similar scheme may be employed for supply voltages anywhere in the operating range of +1.5V to +10V, keeping in mind that pin 6 (LV) is tied to the supply negative (GND) only for supply voltages below 3.5V.

The output characteristics of the circuit in Figure 3 are those of a nearly ideal voltage source in series with 70Ω. Thus, for a load current of –10 mA and a supply voltage of +5V, the output voltage would be –4.3V.

The dynamic output impedance of the TC7660H is due, primarily, to capacitive reactance of the charge transfer capacitor (C_1). Since this capacitor is connected to the output for only 1/2 of the cycle, the equation is:

$$X_C = \frac{2}{2\pi f C_1} = 2.12\Omega,$$

where $f = 150\text{kHz}$ and $C_1 = 1.0\mu\text{F}$.

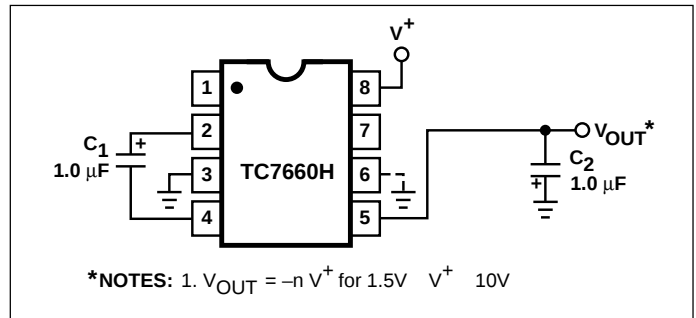


Figure 3. Simple Negative Converter

Paralleling Devices

Any number of TC7660H voltage converters may be paralleled to reduce output resistance (Figure 4). The reservoir capacitor, C_2 , serves all devices, while each device requires its own pump capacitor, C_1 . The resultant output resistance would be approximately:

$$R_{OUT} = \frac{R_{OUT} \text{ (of TC7660H)}}{n \text{ (number of devices)}}$$

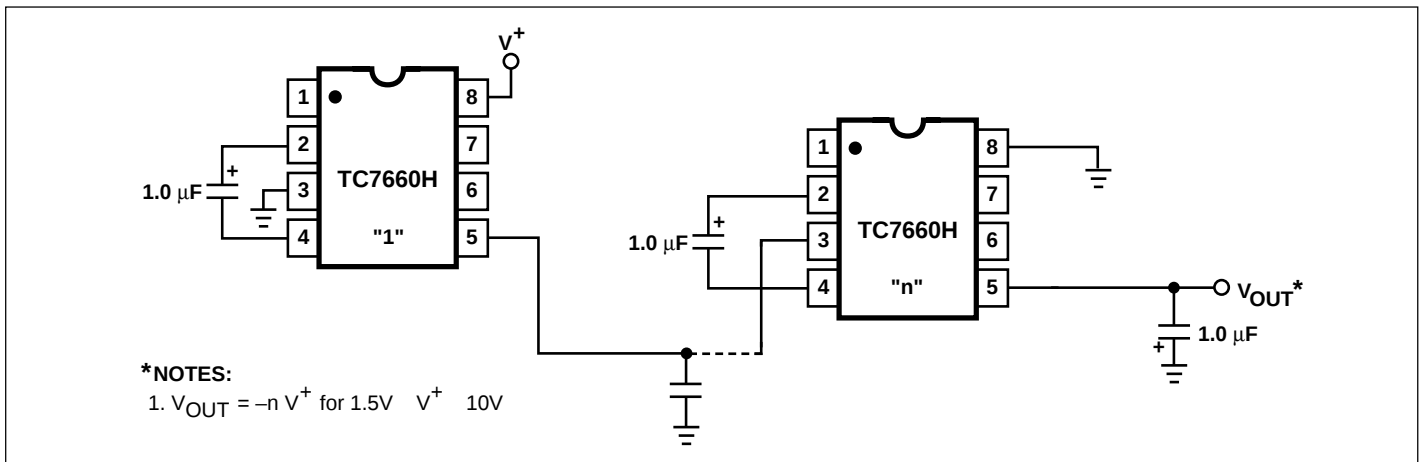


Figure 4. Increased Output Voltage by Cascading Devices

Cascading Devices

The TC7660H may be cascaded as shown in (Figure 4) to produce larger negative multiplication of the initial supply voltage. However, due to the finite efficiency of each device, the practical limit is probably 10 devices for light loads. The output voltage is defined by:

$$V_{OUT} = -n (V_{IN})$$

where n is an integer representing the number of devices cascaded. The resulting output resistance would be approximately the weighted sum of the individual TC7660H R_{OUT} values.

Changing the TC7660H Oscillator Frequency

It may be desirable in some applications (due to noise or other considerations) to increase or decrease the oscillator frequency. This can be achieved by overdriving the oscillator from an external clock, as shown in Figure 6. In order to prevent possible device latch-up, a 1kΩ resistor must be used in series with the clock output. In a situation where the designer has generated the external clock frequency using TTL logic, the addition of a 10kΩ pull-up resistor to V^+ supply is required. Note that the pump frequency with external clocking, as with internal clocking, will be 1/2 of the clock frequency. Output transitions occur on the positive-going edge of the clock.

HIGH FREQUENCY 7660 DC-TO-DC VOLTAGE CONVERTER

TC7660H

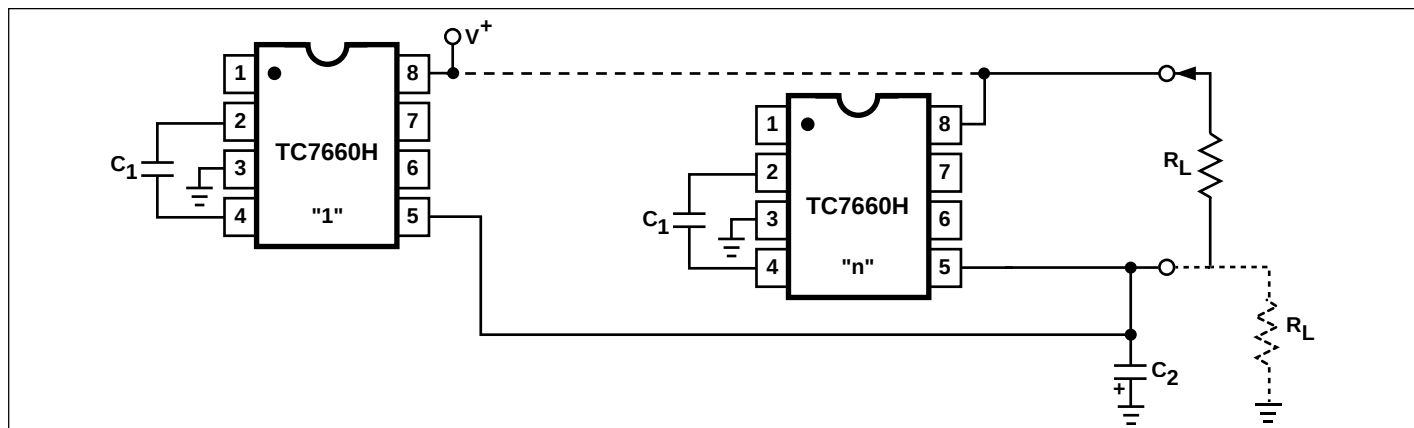


Figure 5. Paralleling Devices Lowers Output Impedance

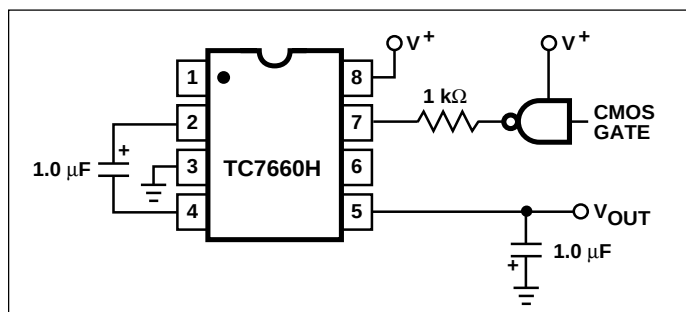


Figure 6. External Clocking

Positive Voltage Multiplication

The TC7660H may be employed to achieve positive voltage multiplication using the circuit shown in Figure 7. In this application, the pump inverter switches of the TC7660H are used to charge C_1 to a voltage level of $V^+ - V_F$ (where V^+ is the supply voltage and V_F is the forward voltage drop of diode D_1). On the transfer cycle, the voltage on C_1 plus the supply voltage (V^+) is applied through diode D_2 to capacitor C_2 . The voltage thus created on C_2 becomes $(2V^+) - (2V_F)$, or twice the supply voltage minus the combined forward voltage drops of diodes D_1 and D_2 .

The source impedance of the output (V_{OUT}) will depend on the output current, but for $V^+ = 5V$ and an output current of 10mA, it will be approximately 60Ω.

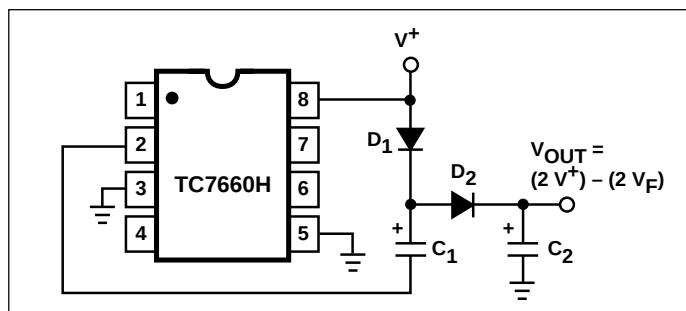


Figure 7. Positive Voltage Multiplier

Combined Negative Voltage Conversion and Positive Supply Multiplication

Figure 8 combines the functions shown in Figures 3 and 8 to provide negative voltage conversion and positive voltage multiplication simultaneously. This approach would be, for example, suitable for generating +9V and -5V from an existing +5V supply. In this instance, capacitors C_1 and C_3 perform the pump and reservoir functions, respectively, for the generation of the negative voltage, while capacitors C_2 and C_4 are pump and reservoir, respectively, for the multiplied positive voltage. There is a penalty in this configuration which combines both functions, however, in that the source impedances of the generated supplies will be somewhat higher due to the finite impedance of the common charge pump driver at pin 2 of the device.

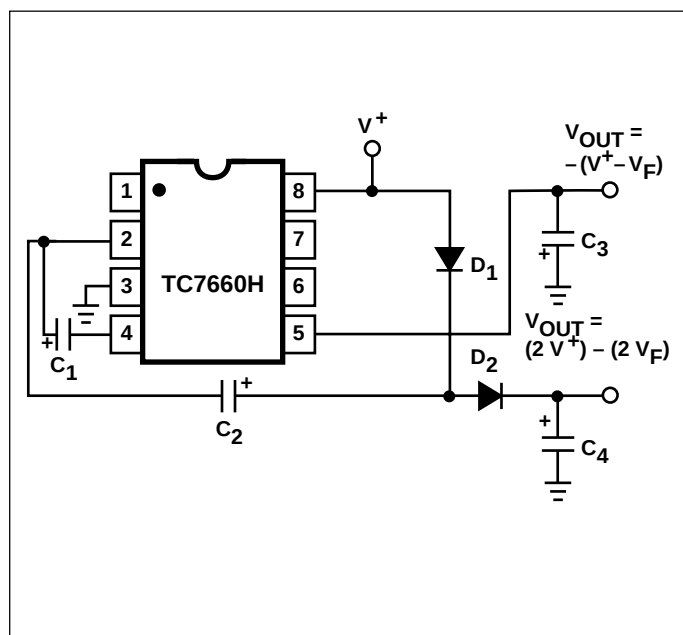


Figure 8. Combined Negative Converter and Positive Multiplier

HIGH FREQUENCY 7660 DC-TO-DC
VOLTAGE CONVERTER

TC7660H

Efficient Positive Voltage Multiplication/
Conversion

Since the switches that allow the charge pumping operation are bidirectional, the charge transfer can be performed backwards as easily as forwards. Figure 9 shows a TC7660H transforming -5V to $+5\text{V}$ (or $+5\text{V}$ to $+10\text{V}$, etc.). The only problem here is that the internal clock and switch-drive section will not operate until some positive voltage has been generated. An initial inefficient pump, as shown in Figure 9, could be used to start this circuit up, after which it will bypass the diode and resistor shown dotted in Figure 9.

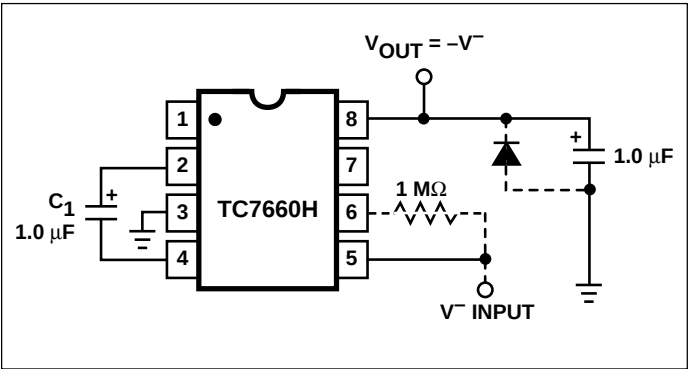
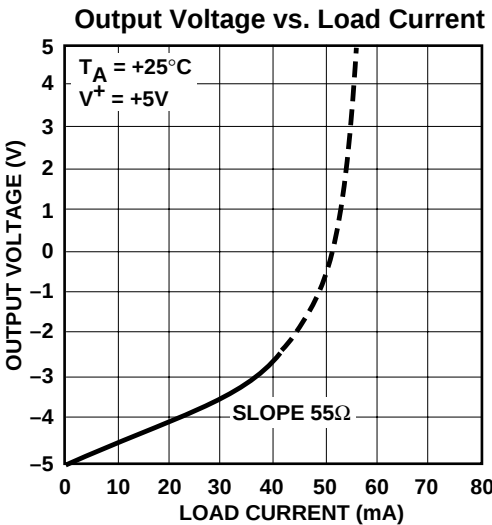
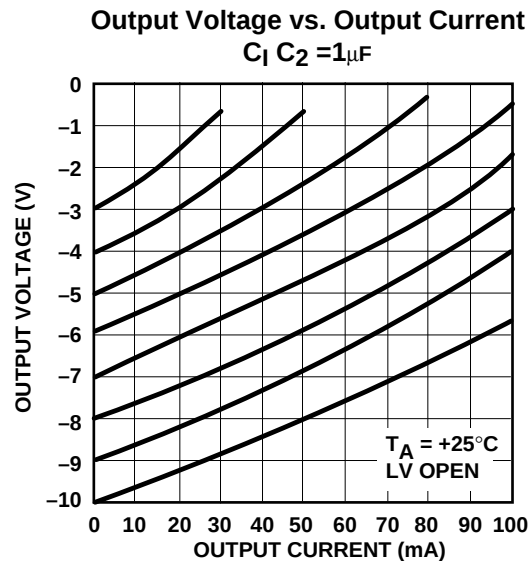
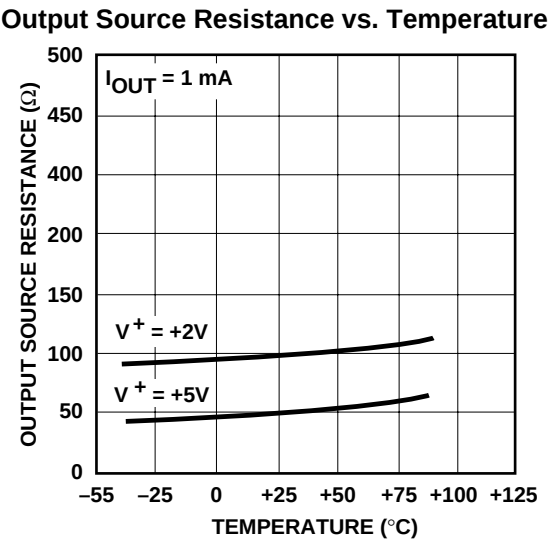
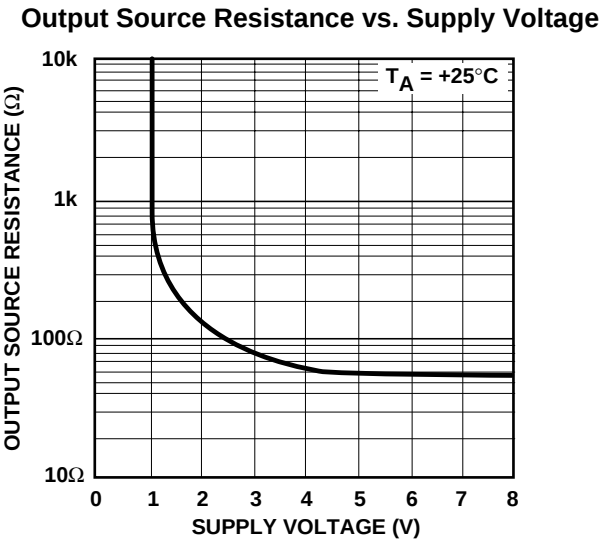


Figure 9. Positive Voltage Conversion

TYPICAL PERFORMANCE CHARACTERISTICS (Circuit of Figure 1)

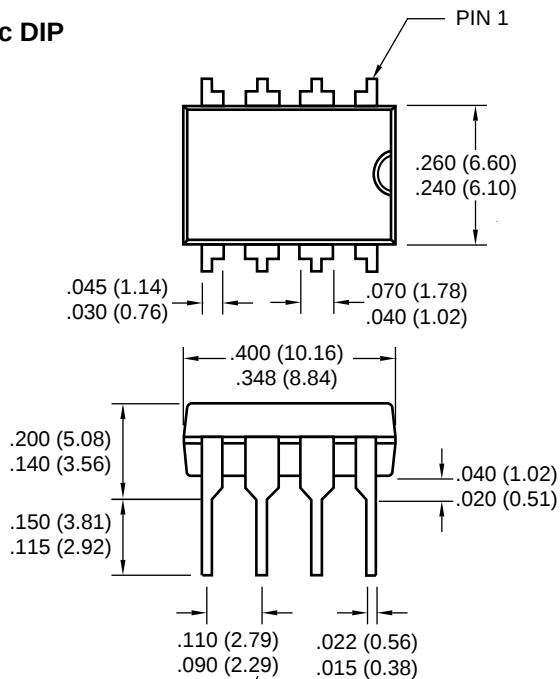


HIGH FREQUENCY 7660 DC-TO-DC VOLTAGE CONVERTER

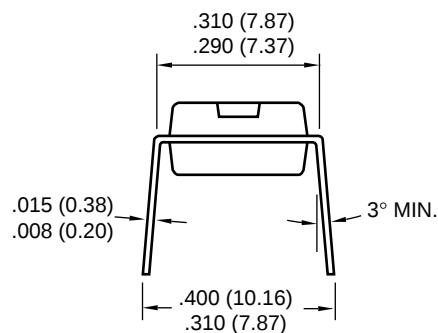
TC7660H

PACKAGE DIMENSIONS

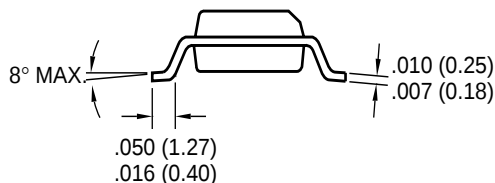
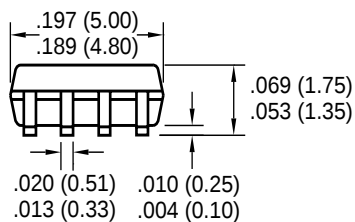
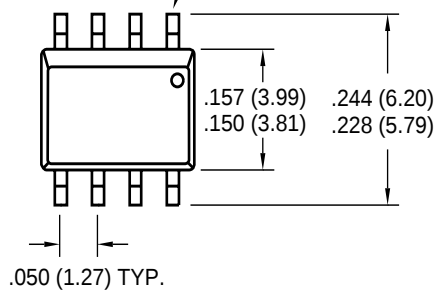
8-Pin Plastic DIP



Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



8-Pin SOIC



Dimensions: inches (mm)



WORLDWIDE SALES AND SERVICE

AMERICAS

Corporate Office

2355 West Chandler Blvd.
Chandler, AZ 85224-6199
Tel: 480-792-7200 Fax: 480-792-7277
Technical Support: 480-792-7627
Web Address: <http://www.microchip.com>

Rocky Mountain

2355 West Chandler Blvd.
Chandler, AZ 85224-6199
Tel: 480-792-7966 Fax: 480-792-7456

Atlanta

500 Sugar Mill Road, Suite 200B
Atlanta, GA 30350
Tel: 770-640-0034 Fax: 770-640-0307

Austin

Analog Product Sales
8303 MoPac Expressway North
Suite A-201
Austin, TX 78759
Tel: 512-345-2030 Fax: 512-345-6085

Boston

2 Lan Drive, Suite 120
Westford, MA 01886
Tel: 978-692-3848 Fax: 978-692-3821

Boston

Analog Product Sales
Unit A-8-1 Millbrook Tarry Condominium
97 Lowell Road
Concord, MA 01742
Tel: 978-371-6400 Fax: 978-371-0050

Chicago

333 Pierce Road, Suite 180
Itasca, IL 60143
Tel: 630-285-0071 Fax: 630-285-0075

Dallas

4570 Westgrove Drive, Suite 160
Addison, TX 75001
Tel: 972-818-7423 Fax: 972-818-2924

Dayton

Two Prestige Place, Suite 130
Miamisburg, OH 45342
Tel: 937-291-1654 Fax: 937-291-9175

Detroit

Tri-Atria Office Building
32255 Northwestern Highway, Suite 190
Farmington Hills, MI 48334
Tel: 248-538-2250 Fax: 248-538-2260

Los Angeles

18201 Von Karman, Suite 1090
Irvine, CA 92612
Tel: 949-263-1888 Fax: 949-263-1338

Mountain View

Analog Product Sales
1300 Terra Bella Avenue
Mountain View, CA 94043-1836
Tel: 650-968-9241 Fax: 650-967-1590

New York

150 Motor Parkway, Suite 202
Hauppauge, NY 11788
Tel: 631-273-5305 Fax: 631-273-5335

San Jose

Microchip Technology Inc.
2107 North First Street, Suite 590
San Jose, CA 95131
Tel: 408-436-7950 Fax: 408-436-7955

Toronto

6285 Northam Drive, Suite 108
Mississauga, Ontario L4V 1X5, Canada
Tel: 905-673-0699 Fax: 905-673-6509

ASIA/PACIFIC

China - Beijing

Microchip Technology Beijing Office
Unit 915
New China Hong Kong Manhattan Bldg.
No. 6 Chaoyangmen Beidajie
Beijing, 100027, No. China
Tel: 86-10-85282100 Fax: 86-10-85282104

China - Shanghai

Microchip Technology Shanghai Office
Room 701, Bldg. B
Far East International Plaza
No. 317 Xian Xia Road
Shanghai, 200051
Tel: 86-21-6275-5700 Fax: 86-21-6275-5060

Hong Kong

Microchip Asia Pacific
RM 2101, Tower 2, Metroplaza
223 Hing Fong Road
Kwai Fong, N.T., Hong Kong
Tel: 852-2401-1200 Fax: 852-2401-3431

India

Microchip Technology Inc.
India Liaison Office
Divyasree Chambers
1 Floor, Wing A (A3/A4)
No. 11, O'Shaughnessy Road
Bangalore, 560 025, India
Tel: 91-80-2290061 Fax: 91-80-2290062

Japan

Microchip Technology Intl. Inc.
Benex S-1 6F
3-18-20, Shinyokohama
Kohoku-Ku, Yokohama-shi
Kanagawa, 222-0033, Japan
Tel: 81-45-471-6166 Fax: 81-45-471-6122

Korea

Microchip Technology Korea
168-1, Youngbo Bldg. 3 Floor
Samsung-Dong, Kangnam-Ku
Seoul, Korea
Tel: 82-2-554-7200 Fax: 82-2-558-5934

ASIA/PACIFIC (continued)

Singapore

Microchip Technology Singapore Pte Ltd.
200 Middle Road
#07-02 Prime Centre
Singapore, 188980
Tel: 65-334-8870 Fax: 65-334-8850

Taiwan

Microchip Technology Taiwan
11F-3, No. 207
Tung Hua North Road
Taipei, 105, Taiwan
Tel: 886-2-2717-7175 Fax: 886-2-2545-0139

EUROPE

Australia

Microchip Technology Australia Pty Ltd
Suite 22, 41 Rawson Street
Epping 2121, NSW
Australia
Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

Denmark

Microchip Technology Denmark ApS
Regus Business Centre
Lautrup høj 1-3
Ballerup DK-2750 Denmark
Tel: 45 4420 9895 Fax: 45 4420 9910

France

Arizona Microchip Technology SARL
Parc d'Activite du Moulin de Massy
43 Rue du Saule Trapu
Batiment A - 1er Etage
91300 Massy, France
Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

Germany

Arizona Microchip Technology GmbH
Gustav-Heinemann Ring 125
D-81739 Munich, Germany
Tel: 49-89-627-144 0 Fax: 49-89-627-144-44

Germany

Analog Product Sales
Lochhamer Strasse 13
D-82152 Martinsried, Germany
Tel: 49-89-895650-0 Fax: 49-89-895650-22

Italy

Arizona Microchip Technology SRL
Centro Direzionale Colleoni
Palazzo Taurus 1 V. Le Colleoni 1
20041 Agrate Brianza
Milan, Italy
Tel: 39-039-65791-1 Fax: 39-039-6899883

United Kingdom

Arizona Microchip Technology Ltd.
505 Eskdale Road
Winnersh Triangle
Wokingham
Berkshire, England RG41 5TU
Tel: 44 118 921 5869 Fax: 44-118 921-5820

All rights reserved. © 2001 Microchip Technology Incorporated. Printed in the USA. 1/01  Printed on recycled paper.

01/09/01

Information contained in this publication regarding device applications and the like is intended through suggestion only and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. No representation or warranty is given and no liability is assumed by Microchip Technology Incorporated with respect to the accuracy or use of such information, or infringement of patents or other intellectual property rights arising from such use or otherwise. Use of Microchip's products as critical components in life support systems is not authorized except with express written approval by Microchip. No licenses are conveyed, implicitly or otherwise, except as maybe explicitly expressed herein, under any intellectual property rights. The Microchip logo and name are registered trademarks of Microchip Technology Inc. in the U.S.A. and other countries. All rights reserved. All other trademarks mentioned herein are the property of their respective companies.